

SH7000 Series

32 Bit × 32 Bit = 64 Bit (Signed)

Label: MULS32

Functions Used: MULU Instruction
SWAP Instruction
NEGC Instruction

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1. Function

Multiplies the multiplicand (signed 32 bits) by the multiplier (signed 32 bits) and determines the product (signed 64 bits).

2. Arguments

Description		Storage Location	Data Length (Bytes)
Input	Multiplicand (signed 32 bits)	R0	4
	Multiplier (signed 32 bits)	R1	4
Output	Upper 32 bits of product (signed 64 bits)	R2	4
	Lower 32 bits of product (signed 64 bits)	R3	4

3. Internal Register Changes and Flag Changes

(Before Execution) → (After Execution)	
R0	Multiplicand (unsigned 32 bits) → No change
R1	Multiplier (unsigned 32 bits) → Change
R2	Undefined → Product (upper 32 bits)
R3	Undefined → Product (lower 32 bits)
R4	Work
R5	Work
R6	Work
R7	
R8	
R9	
R10	
R11	
R12	
R13	
R14	
R15	(SP)

T bit

*

 — : No change
* : Change
0 : Fixed 0
1 : Fixed 1

4. Programming Specifications

Program memory (bytes)
92
Data memory (bytes)
0
Stack (bytes)
16
Number of states
48
Reentrant
Yes
Relocation
Yes
Intermediate interrupt
Yes

5. Notes

The number of states indicated in the programming specifications is the value when $H'7FFFFFFF \times H'80000000$ is calculated.

6. Description

(1) Function

Details of the arguments are as follows.

R0: Set the multiplicand (signed 32 bits) as the input argument.

R1: Set the multiplier (signed 32 bits) as the input argument.

R2: Holds the upper 32 bits of the product (signed 64 bits) as the output argument.

R3: Holds the lower 32 bits of the product (signed 64 bits) as the output argument.

Figure 1 shows a software MULS32 execution example.

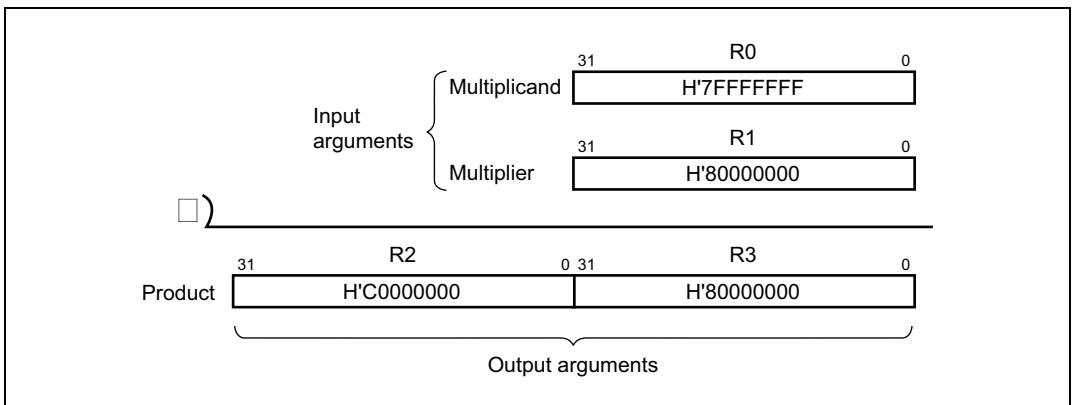


Figure 1 Software MULS32 Execution Example

(2) Usage Notes

The contents of R1, which sets the multiplier, are changed by execution of the software MULS32 instruction. If the value for the multiplier will be needed after the software MULS32 instruction is executed, it should be saved beforehand.

(3) RAM Used

No RAM is used by the software MULS32 instruction.

(4) Usage Example

After the multiplicand and multiplier are set, the software instruction MULS32 is executed by a subroutine call.

```

MOV.L DATA1,R0    . . . . Sets multiplicand in input argument (R0)
BSR   MULU32       . . . . Subroutine call to software instruction MULS32
MOV.L DATA2,R1    . . . . Sets multiplier in input argument (R1)
.
.
.
.align 4
DATA1 .data.l H'7FFFFFFF
DATA2 .data.l H'80000000
    
```

(5) Operating Principle

- As shown in figure 2, multiplication is performed in 16 bit units. Partial products (1–4) are determined, and these are added to get the final 64-bit product. The 16-bit unsigned multiplication instruction (MULU) is used in multiplication of partial products, so if the multiplicand or multiplier are negative, they are converted to positive before multiplication.
- The product is calculated as positive, so the determination of whether it is positive or negative is made using exclusive OR on the multiplicand and multiplier MSB, as shown in table 1.

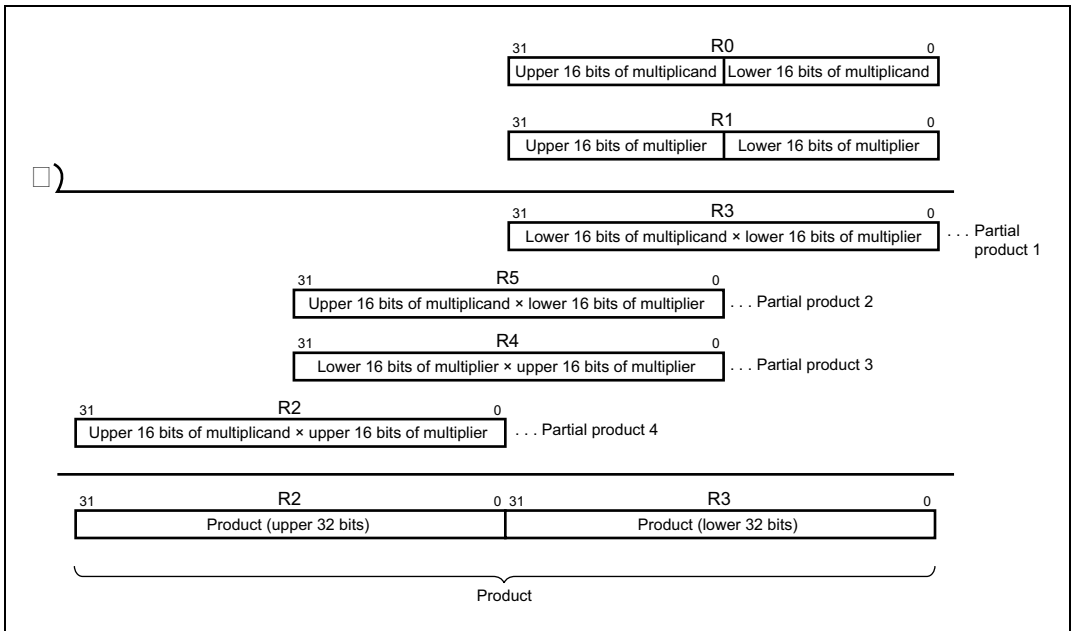
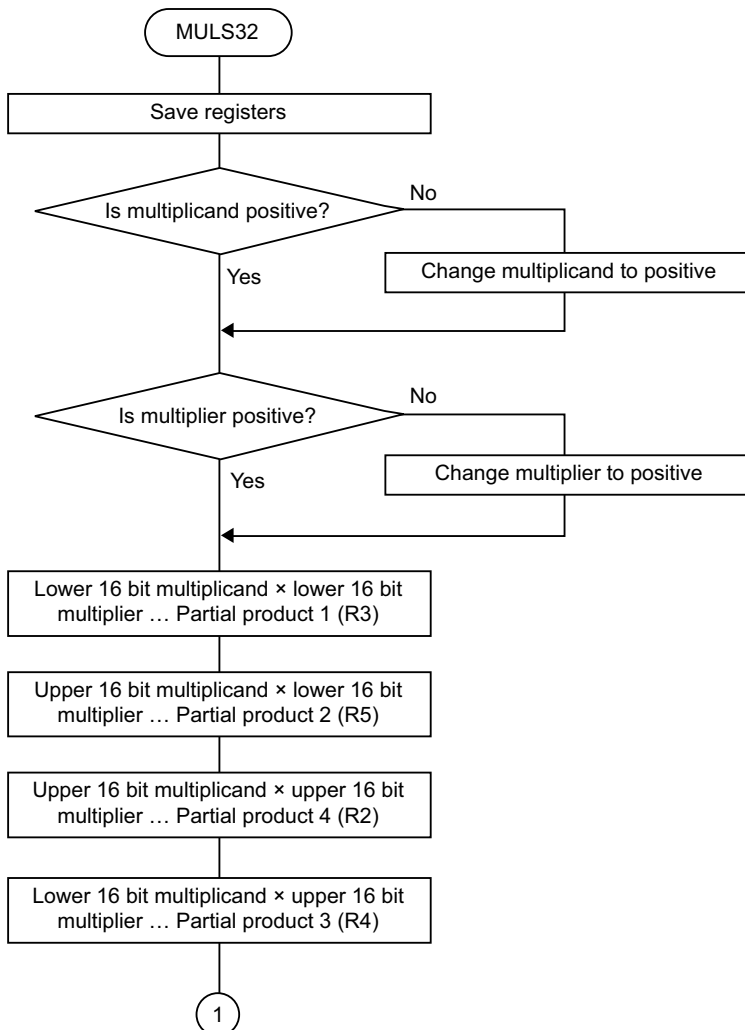


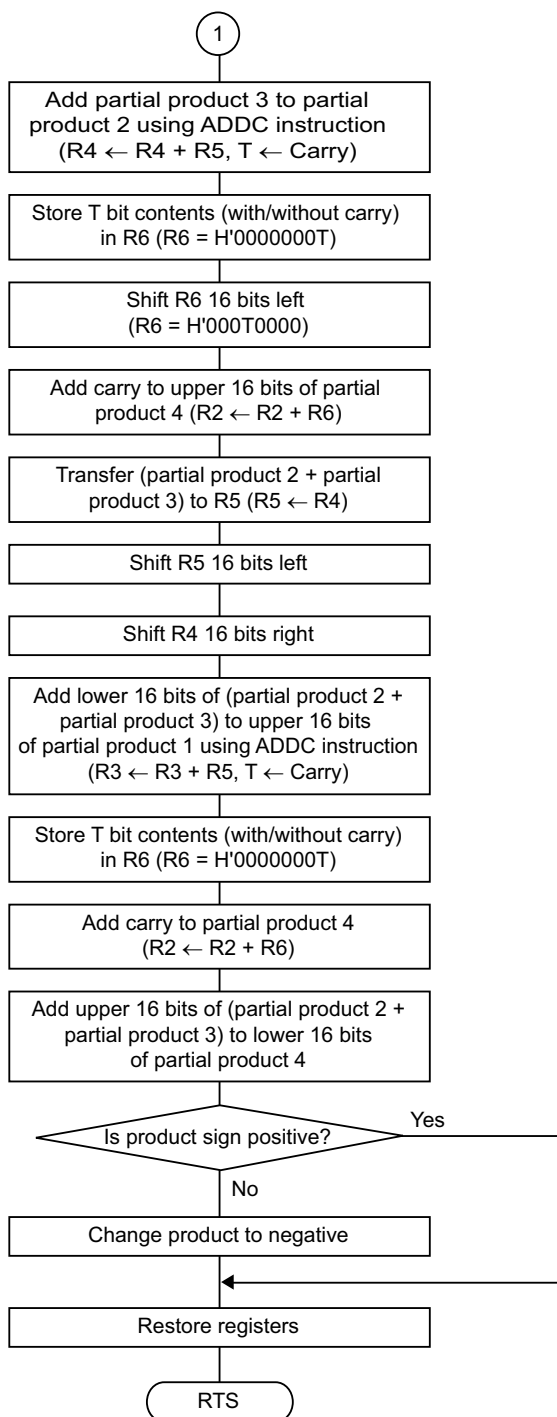
Figure 2 Multiplication

Table 1 Product Sign Changes

MSB of Multiplicand	MSB of Multiplier	Product Sign Change
Positive	Positive	Positive
Positive	Negative	Negative
Negative	Positive	Negative
Negative	Negative	Positive

7. Flowchart





8. Program Listing

```

1      1      ;*****
2      2      ;*
3      3      ;*      NAME : 32 BIT SINGNED MULTIPLATION (MULS32)      *
4      4      ;*
5      5      ;*****
6      6      ;*
7      7      ;*      ENTRY : R0 (MULTIPLICAND)      *
8      8      ;*      R1 (MULTIPLIER)      *
9      9      ;*      RETURNS : R2 (UPPER 32 BIT PRODUCT)      *
10     10     ;*      R3 (LOWER 32 BIT PRODUCT)      *
11     11     ;*
12     12     ;*****
13     13     .SECTION A,CODE,LOCATE=H'1000
14     14     MULS32 .EQU $      ; Entry point
15     15     STS.L   MACL,@-R15 ; Escape register
16     16     MOV.L   R4,@-R15 ;
17     17     MOV.L   R5,@-R15 ;
18     18     MOV.L   R6,@-R15 ;
19     19
20     20     CMP/PZ  R0      ; Multiplicand >= 0 ?
21     21     BT      MULS321 ; Yes
22     22     NEG     R0,R0   ; Change plus
23     23     MULS321
24     24     CMP/PZ  R1      ; Multiplier >= 0 ?
25     25     BT      MULS322 ; Yes
26     26     NEG     R1,R1   ; Change plus
27     27     MULS322
28     28     MULU    R1,R0    ; Lower 16 bit + lower 16 bit -> R3
29     29     SWAP.W  R0,R0    ;
30     30     STS     MACL,R3  ;
31     31     MULU    R1,R0    ; Upper 16 bit + lower 16 bit -> R5
32     32     SWAP.W  R1,R1    ;
33     33     STS     MACL,R5  ;
34     34     MULU    R1,R0    ; Upper 16 bit + upper 16 bit -> R2
35     35     SWAP.W  R0,R0    ;
36     36     STS     MACL,R2  ;
37     37     MULU    R1,R0    ; Lower 16 bit + upper 16 bit -> R4
38     38     SWAP.W  R1,R1    ;
39     39     STS     MACL,R4  ;
40     40
41     41     CLRT
42     42     ADDC     R5,R4    ;
43     43     MOVT    R6      ; R6 <- Carry
44     44     SHLL16  R6      ;
45     45     ADD     R6,R2    ; Carry = 1  R2 <- R2 + H'00010000
46     46     ; Carry = 0  R2 <- R2 + H'00000000
47     47     MOV     R4,R5    ;
48     48     SHLL16  R5      ;
49     49     SHLR16  R4      ;

```

```

50                                     ;
51 0000103C 0000      51      CLRT      ;
52 0000103E 335E      52      ADDC      R5,R3      ;
53 00001040 0629      53      MOV      R6      ; R6 <- Carry
54 00001042 326C      54      ADD      R6,R2      ; Carry = 1  R2 <- R2 + H'00000001
55                                     ; Carry = 0  R2 <- R2 + H'00000000
56 00001044 324C      56      ADD      R4,R2      ;
57                                     ;
58 00001046 210A      58      XOR      R0,R1      ; Product < 0 ?
59 00001048 4100      59      SHLL      R1      ;
60                                     ;
61 0000104A 8B02      61      BF      MULS32_END ; No
62 0000104C 0008      62      CLRT      ; Change minus
63 0000104E 633A      63      NEGC      R3,R3      ;
64 00001050 622A      64      NEGC      R2,R2      ;
65 00001052      65      MULS32_END      ;
66 00001052 66F6      66      MOV.L      @R15+,R6 ; Return register
67 00001054 65F6      67      MOV.L      @R15+,R5 ;
68 00001056 64F6      68      MOV.L      @R15+,R4 ;
69 00001058 000B      69      RTS      ;
70 0000105A 4F16      70      LDS.L      @R15+,MACL ;
71                                     ;
71      .END
*****TOTAL ERRORS      0
*****TOTAL WARNINGS    0

```

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